VLRE31R1S2



Vishay Semiconductors

Reverse Gullwing SMD LED Yellow



DESCRIPTION

This device has been designed to meet the increasing demand for AllnGaP technology.

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

LED is mounted top down and emits through the PCB.

PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- · Package: SMD reverse gullwing
- · Product series: standard
- Angle of half intensity: ± 60°

FEATURES

- SMD LED with exceptional brightness
- · Luminous intensity categorized
- Compatible with automatic placement equipment
- EIA and ICE standard package
- · Compatible with IR reflow, vapor phase and wave solder processes according to CECC 00802 and J-STD-020C
- Available in 12 mm tape
- Low profile package
- · Non-diffused lens: Excellent for coupling to light pipes and backlighting
- Low power consumption
- · Luminous intensity ratio in one packaging unit $I_{Vmax}/I_{Vmin} > 1.6$
- Preconditioning according to JEDEC[®] level 2a
- · ESD-withstand voltage: up to 2 kV according to JESD22-A114-B
- AEC-Q101 gualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Automotive: backlighting in dashboards and switches
- Telecommunication: indicator and backlighting in telephone and fax
- · Indicator and backlight for audio and video equipment
- Indicator and backlight in office equipment
- · Flat backlight for LCDs, switches, and symbols
- General use

PARTS TABLE														
PART	COLOR	LUMING	OUS INT (mcd)	ENSITY	at I _F	WAY	VELEN (nm)	GTH	at I _F	FORW	ARD VO (V)	LTAGE	at I _F	TECHNOLOGY
		MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	
VLRE31R1S2-GS08	Yellow	112	-	285	20	581	588	594	20	-	2.1	2.3	20	AllnGaP on GaAs





FREE

GREEN

(5-2008)



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ABSOLUTE MAXIMUM RATI VLRE31	NGS ($T_{amb} = 25 \text{ °C}$, unless otherwise	e specified)		
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage ⁽¹⁾		V _R	5	V
DC forward current	T _{amb} ≤ 85 °C	I _F	30	mA
Surge forward current	t _p ≤ 10 μs	I _{FSM}	1	A
Power dissipation		Pv	75	mW
Junction temperature		Тj	+125	°C
Operating temperature range		T _{amb}	-40 to +100	°C
Storage temperature range		T _{stg}	-40 to +100	°C
Thermal resistance junction-to-ambient	Mounted on PC board (pad size > 16 mm ²)	R _{thJA}	400	K/W

Note

⁽¹⁾ Driving LED in reverse direction is suitable for short term application

OPTICAL AND ELECTRICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified) **VLRE31... YELLOW**

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PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity ⁽¹⁾	I _F = 20 mA	Ι _V	112	-	285	mcd
Dominant wavelength	I _F = 20 mA	λ_d	581	588	594	nm
Peak wavelength	I _F = 20 mA	λρ	-	590	-	nm
Angle of half intensity	I _F = 20 mA	φ	-	± 60	-	deg
Forward voltage	I _F = 20 mA	V _F	-	2.1	2.3	V
Reverse voltage	I _R = 10 μA	V _R	5	-	-	V
Junction capacitance	V _R = 0 V, f = 1 MHz	Cj	-	15	-	pF

Note

 $^{(1)}$ In one packing unit $I_{Vmax.}/I_{Vmin.} > 1.6$

LUMINOUS INTENSITY CLASSIFICATION						
GROUP	LUMINOUS INTENSITY Iv (mcd)					
STANDARD	OPTIONAL	MIN.	MAX.			
R	1	112	140			
	2	140	180			
s	1	180	224			
3	2	224	285			

Note

- Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of \pm 11 %.

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel).

In order to ensure availability, single brightness groups will not be orderable. In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped in any one reel.

In order to ensure availability, single wavelength groups will not be orderable

CROSSING TABLE					
VISHAY	OSRAM				
VLRE31R1S2	LYT776-R1S2				

COLOR CLASSIFICATION					
	DOM. WAVELENGTH (nm) YELLOW				
GROUP					
	MIN.	MAX.			
W	582	585			
Х	585	588			
Y	588	591			
Z	591	594			

Note

 Wavelengths are tested at a current pulse duration of 25 ms and an accuracy of ± 1 nm



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TYPICAL CHARACTERISTICS ($T_{amb} = 25$ °C, unless otherwise specified)

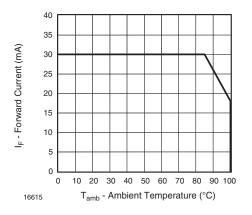


Fig. 1 - Forward Current vs. Ambient Temperature

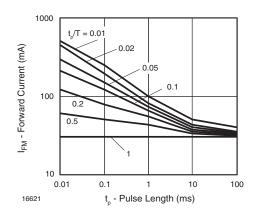


Fig. 2 - Forward Current vs. Pulse Length

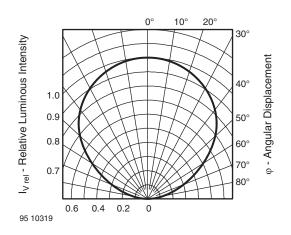


Fig. 3 - Relative Luminous Intensity vs. Angular Displacement

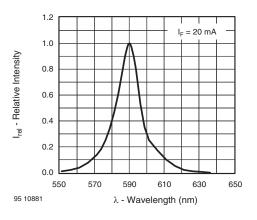


Fig. 4 - Relative Intensity vs. Wavelength

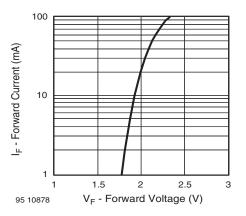


Fig. 5 - Forward Current vs. Forward Voltage

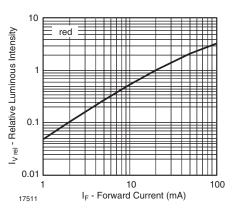


Fig. 6 - Relative Luminous Intensity vs. Forward Current

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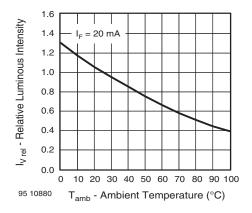


Fig. 7 - Relative Luminous Intensity vs. Ambient Temperature

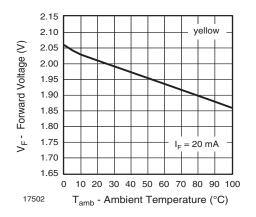


Fig. 8 - Forward Voltage vs. Ambient Temperature

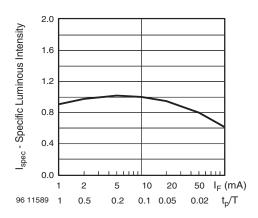


Fig. 9 - Relative Luminous Intensity vs. Forward Current/Duty Cycle

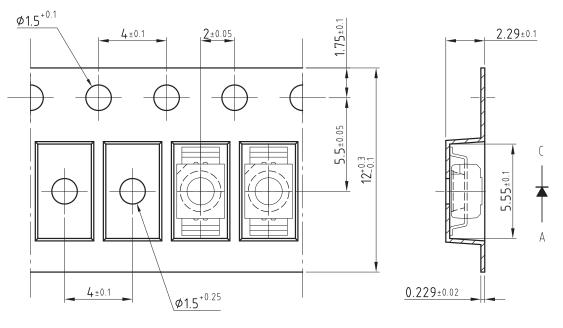
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TAPING DIMENSIONS in millimeters

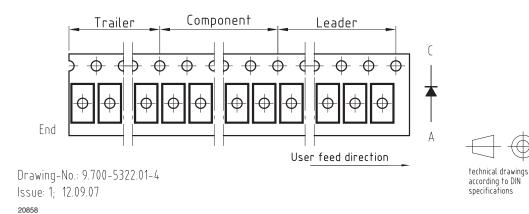
Taping and orientation

Reels come in quantity of 2000 units. Reel diameters are 180 mm.



200 mm min. for Ø 180 reel

480 mm min. for ϕ 180 reel

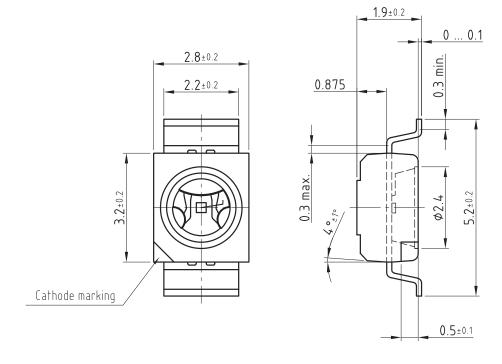


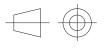


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PACKAGE DIMENSIONS in millimeters



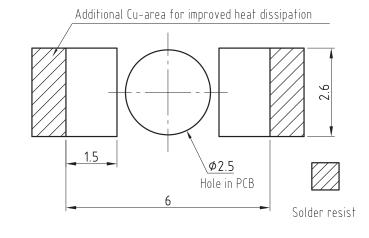


technical drawings according to DIN specifications

Issue: 1; 21.08.07

20859

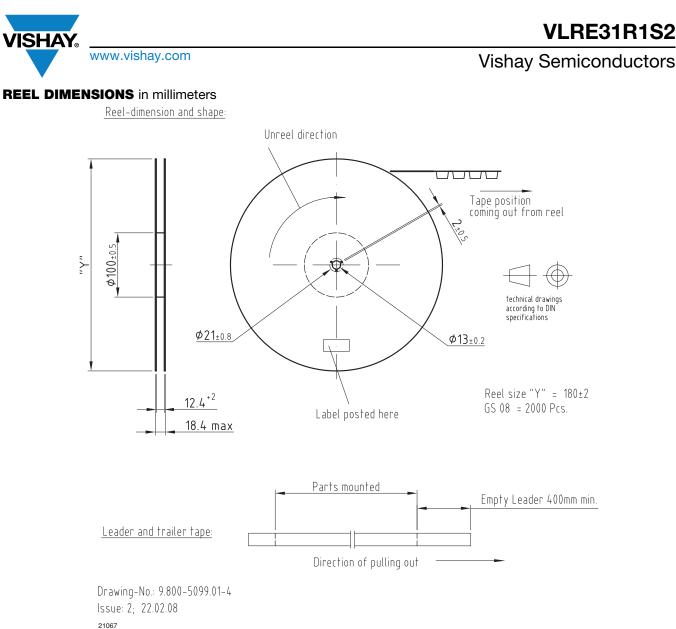
Drawing-No.: 6.541-5073.01-4



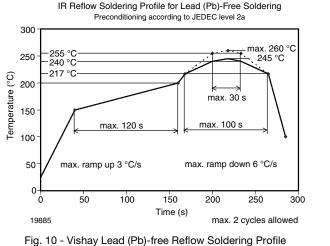
Recommended solder pad

Rev. 1.5, 23-Feb-18

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SOLDERING PROFILE



(according to J-STD-020C)

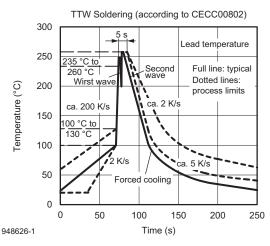


Fig. 11 - Double Wave Soldering of Opto Devices (all Packages)

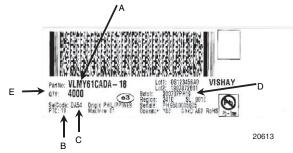
Rev. 1.5, 23-Feb-18

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LABEL OF FAN FOLD BOX (example)

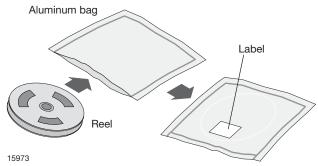


A. Type of component

- B. PTC = manufacturing plant
- C. SEL selection code (bin): e.g.: U2 = code for luminous intensity group
- D. Batch / date code
- E. Company code
- F. Code for lead (Pb)-free classification (e3)

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

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RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 $^\circ\text{C}$ + 5 $^\circ\text{C}$ / - 0 $^\circ\text{C}$ and < 5 % RH (dry air / nitrogen) or

96 h at 60 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.

CAUTION This bag contains MOISTURE -SENSITIVE DEVICES
1. Shelf life in sealed bag 12 months at <40 $^{\circ}\mathrm{C}$ and < 90% relative humidity (RH)
 2. After this bag is opened devices that will be subjected to infrared reflow, vapor-phase reflow, or equivalent processing (peak package body temp. 260°C) must be: a) Mounted within 672 hours at factory condition of ≤ 30°C/60%RH or b) Stored at ≤10% RH.
 3. Devices require baking before mounting if: a) Humidity Indicator Card is >10% when read at 23°C ± 5°C or b) 2a or 2b is not met.
4. If baking is required, devices may be baked for: 192 hours at 40°C + 5°C/-0°C and <5%RH (dry air/nitrogen)
Bag Seal Date:
Note: LEVEL defined by EIA JEDEC Standard JESD22-A113

Example of JESD22-A112 level 2a label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

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